
HB56S872ESN-6B/7B/8B

8,388,608-word $\times$ 72-bit High Density Dynamic RAM Module
168-pin JEDEC Standard Outline Unbuffered 8 byte DIMM

HITACHI

ADE-203-611 (Z)
Preliminary Rev. 0.0
Jun. 14, 1996

Description

The HB56S872ESN belongs to 8 Byte DIMM (Dual In-line Memory Module) family, and has been developed as an optimized main memory solution for 4 and 8 Byte processor applications.

The HB56S872ESN is a $8M \times 72$ dynamic RAM module, mounted 36 pieces of 16-Mbit DRAM (HM5116405) sealed in TCP package and 1 pieces of serial EEPROM (24C02) for Presence Detect (PD). The HB56S872ESN offers Extended Data Out (EDO) Page Mode as a high speed access mode. An outline of the HB56S872ESN is 168-pin socket type package (dual lead out). Therefore, the HB56S872ESN makes high density mounting possible without surface mount technology. The HB56S872ESN provides common data inputs and outputs. Decoupling capacitors are mounted beneath each TCP on the module board.

Features

- 168-pin socket type package (Dual lead out)
 - Lead pitch: 1.27 mm
- Single 5.0 V ($\pm 5\%$) supply
- High speed
 - Access time: $t_{RAC} = 60/70/80$ ns (max)
 - Access time: $t_{CAC} = 15/18/20$ ns (max)
- Low power dissipation
 - Active mode: 8.03/7.09/6.62 W (max)
 - Standby mode (TTL): 378 mW (max)
 - Standby mode (CMOS): 189 mW (max)
- EDO page mode capability
- 4,096 refresh cycle: 64 ms
- 3 variations of refresh
 - $\overline{RAS}$ -only refresh
 - $\overline{CAS}$ -before- $\overline{RAS}$ refresh
 - Hidden refresh

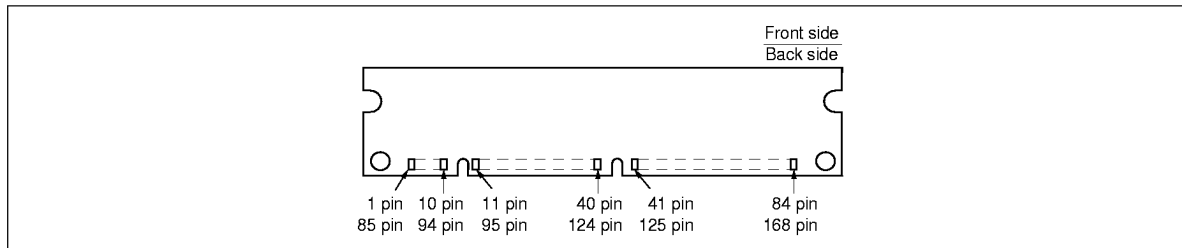
Preliminary: This document contains information on a new product. Specifications and information contained herein are subject to change without notice

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Ordering Information

Type No.	Access time	Package	Contact pad
HB56S872ESN-6B	60 ns	168-pin dual lead out socket type	Gold
HB56S872ESN-7B	70 ns		
HB56S872ESN-8B	80 ns		

Pin Arrangement



Pin Arrangement

Pin No.	Pin Name	Pin No.	Pin Name	Pin No.	Pin Name	Pin No.	Pin Name
1	V _{SS}	13	DQ9	25	NC	37	A8
2	DQ0	14	DQ10	26	V _{CC}	38	A10
3	DQ1	15	DQ11	27	WE0	39	NC
4	DQ2	16	DQ12	28	CAS0	40	V _{CC}
5	DQ3	17	DQ13	29	CAS1	41	V _{CC}
6	V _{CC}	18	V _{CC}	30	RAS0	42	NC
7	DQ4	19	DQ14	31	OE0	43	V _{SS}
8	DQ5	20	DQ15	32	V _{SS}	44	OE2
9	DQ6	21	CB0	33	A0	45	RAS2
10	DQ7	22	CB1	34	A2	46	CAS2
11	DQ8	23	V _{SS}	35	A4	47	CAS3
12	V _{SS}	24	NC	36	A6	48	WE2

Pin Arrangement (cont)

Pin No.	Pin Name	Pin No.	Pin Name	Pin No.	Pin Name	Pin No.	Pin Name
49	V _{CC}	79	NC	109	NC	139	DQ48
50	NC	80	NC	110	V _{CC}	140	DQ49
51	NC	81	NC	111	NC	141	DQ50
52	CB2	82	SDA	112	CAS4	142	DQ51
53	CB3	83	SCL	113	CAS5	143	V _{CC}
54	V _{SS}	84	V _{CC}	114	RAS1	144	DQ52
55	DQ16	85	V _{SS}	115	NC	145	NC
56	DQ17	86	DQ32	116	V _{SS}	146	NC
57	DQ18	87	DQ33	117	A1	147	NC
58	DQ19	88	DQ34	118	A3	148	V _{SS}
59	V _{CC}	89	DQ35	119	A5	149	DQ53
60	DQ20	90	V _{CC}	120	A7	150	DQ54
61	NC	91	DQ36	121	A9	151	DQ55
62	NC	92	DQ37	122	A11	152	V _{SS}
63	NC	93	DQ38	123	NC	153	DQ56
64	V _{SS}	94	DQ39	124	V _{CC}	154	DQ57
65	DQ21	95	DQ40	125	NC	155	DQ58
66	DQ22	96	V _{SS}	126	NC	156	DQ59
67	DQ23	97	DQ41	127	V _{SS}	157	V _{CC}
68	V _{SS}	98	DQ42	128	NC	158	DQ60
69	DQ24	99	DQ43	129	RAS3	159	DQ61
70	DQ25	100	DQ44	130	CAS6	160	DQ62
71	DQ26	101	DQ45	131	CAS7	161	DQ63
72	DQ27	102	V _{CC}	132	NC	162	V _{SS}
73	V _{CC}	103	DQ46	133	V _{CC}	163	NC
74	DQ28	104	DQ47	134	NC	164	NC
75	DQ29	105	CB4	135	NC	165	SA0
76	DQ30	106	CB5	136	CB6	166	SA1
77	DQ31	107	V _{SS}	137	CB7	167	SA2
78	V _{SS}	108	NC	138	V _{SS}	168	V _{CC}

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Pin Description

Pin Name	Function
A0 to A11	Address Input : A0 to A11 Row Address : A0 to A11 Column Address : A0 to A9 Refresh Address : A0 to A11
DQ0 to DQ63	Data-in/Data-out
$\overline{\text{RAS0}}$ to $\overline{\text{RAS3}}$	Row Address Strobe
$\overline{\text{CAS0}}$ to $\overline{\text{CAS7}}$	Column Address Strobe
$\overline{\text{WE0}}$, $\overline{\text{WE2}}$	Read/Write Enable
$\overline{\text{OE0}}$, $\overline{\text{OE2}}$	Output Enable
SDA	Serial Data Out (Bit0 to 7)
SCL	Clock for Presence Detect
SA0 to SA2	Serial Address Input
CB0 to CB7	Check Bit
V_{CC}	Power Supply
V_{SS}	Ground
NC	No Connection

Serial PD Matrix

Byte Number	Function Described	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Note
0	Number Serial PD Bytes	0	0	0	0	1	1	0	1	13
1	Serial Memory	0	0	0	0	1	0	0	0	256 Byte
2	Fundamental Memory Type	0	0	0	0	0	0	1	0	EDO
3	Number of Rows	0	0	0	0	1	1	0	0	12
4	Number of Columns	0	0	0	0	1	0	1	0	10
5	Number of Banks	0	0	0	0	0	0	1	0	2
6	Data Width	0	1	0	0	1	0	0	0	72
7	Data Width (continued)	0	0	0	0	0	0	0	0	0 (+)
8	Voltage Interface	0	0	0	0	0	0	0	0	5.0 Volt
9	$\overline{\text{RAS}}$ Access Time 60 ns	0	0	1	1	1	1	0	0	
	$\overline{\text{RAS}}$ Access Time 70 ns	0	1	0	0	0	1	1	0	
	$\overline{\text{RAS}}$ Access Time 80 ns	0	1	0	1	0	0	0	0	
10	$\overline{\text{CAS}}$ Access Time 15 ns	0	0	0	0	1	1	1	1	
	$\overline{\text{CAS}}$ Access Time 18 ns	0	0	0	1	0	0	1	0	
	$\overline{\text{CAS}}$ Access Time 23 ns	0	0	0	1	0	1	1	1	
11	Error Detection/Correction	0	0	0	0	0	0	1	0	ECC
12	Refresh Period	0	0	0	0	0	0	0	0	Normal (15.625 μ s)

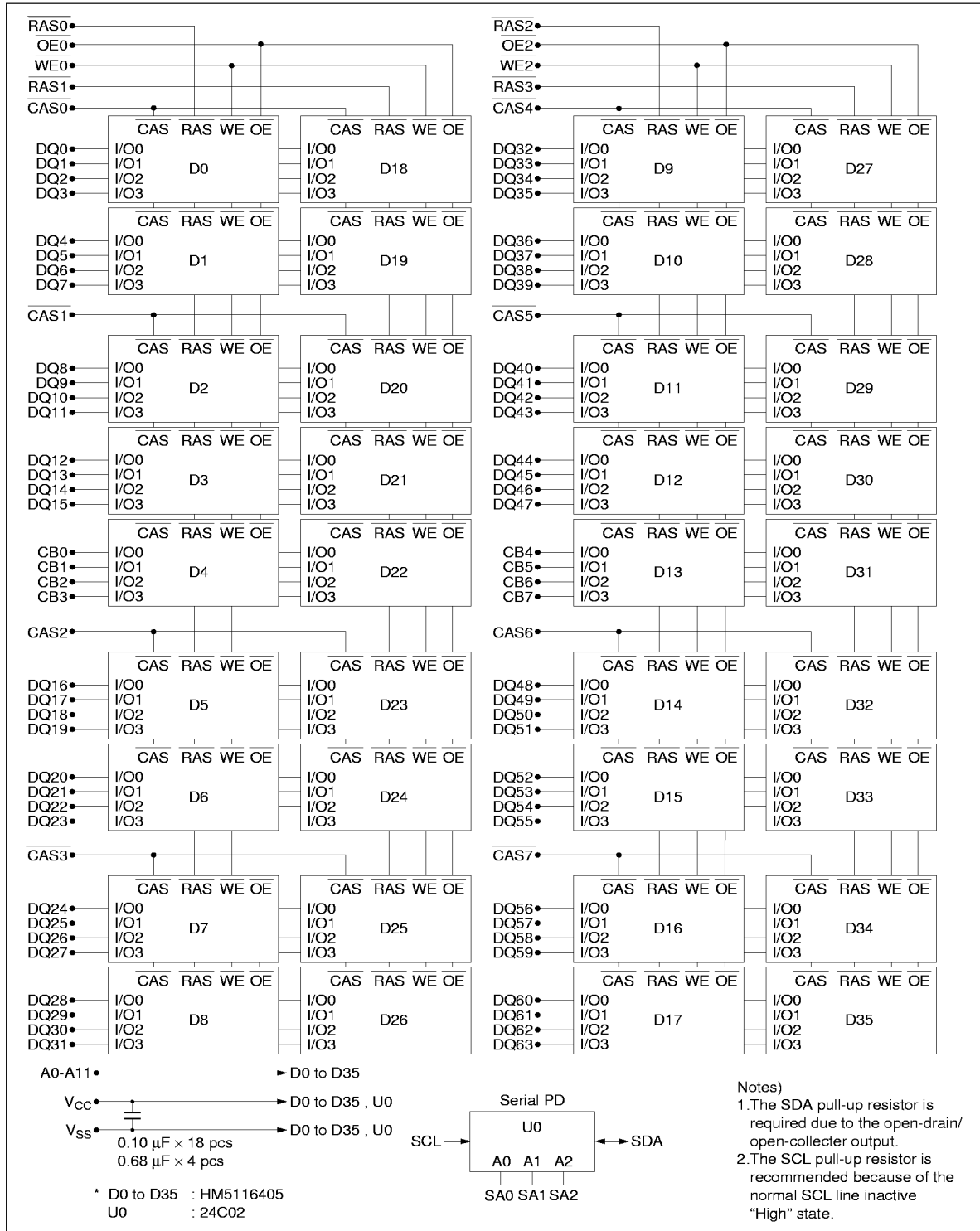
Note: Serial-PD Datas are not protected.

0: Serial Data, "driven to Low"

1: Serial Data, "driven to High"

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Block Diagram



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Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Voltage on any pin relative to V_{SS} . For 10 ns or less	V_T	−0.5 to +7.0 −1.5	V
Supply voltage relative to V_{SS}	V_{CC}	−0.5 to +7.0	V
Short circuit output current	I_{out}	50	mA
Power dissipation	Pt	36	W
Operating temperature	Topr	0 to +70	°C
Storage temperature	Tstg	−55 to +125	°C

Electrical Characteristics**Recommended DC Operating Conditions** ($T_a = 0$ to 70°C)

Parameter	Symbol	Min	Typ	Max	Unit	Note
Supply voltage	V_{SS}	0	0	0	V	
	V_{CC}	4.75	5.0	5.25	V	1
Input high voltage	V_{IH}	2.4	—	5.5	V	1
Input low voltage For 10 ns or less	V_{IL}	−0.5 −1.5	—	0.8	V	1

Note: All voltage referenced to V_{SS} .

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DC Characteristics ($T_a = 0$ to 70°C , $V_{CC} = 5\text{ V} \pm 5\%$, $V_{SS} = 0\text{ V}$)

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Parameter	Symbol	-6B		-7B		-8B		Unit	Test condition	Note
		Min	Max	Min	Max	Min	Max			
Operating current	I_{CC1}	—	1530	—	1350	—	1260	mA	$t_{RC} = \min$	1, 2
Standby current	I_{CC2}	—	72	—	72	—	72	mA	TTL interface $\overline{RAS}, \overline{CAS} = V_{IH}$ Dout = High-Z	
		—	36	—	36	—	36	mA	CMOS interface $\overline{RAS}, \overline{CAS} \geq V_{CC} - 0.2\text{ V}$ Dout = High-Z	
RAS-only refresh current	I_{CC3}	—	1530	—	1350	—	1260	mA	$t_{RC} = \min$	2
Standby current	I_{CC5}	—	180	—	180	—	180	mA	$\overline{RAS} = V_{IH}, \overline{CAS} = V_{IL}$ Dout = enable	1
CAS-before-RAS refresh current	I_{CC6}	—	1530	—	1350	—	1260	mA	$t_{RC} = \min$	
EDO page mode current	I_{CC7}	—	1890	—	1710	—	1530	mA	$t_{HPC} = \min$	1, 3
Input leakage current	I_{LI}	-10	10	-10	10	-10	10	μA	$0\text{ V} \leq V_{in} \leq 5.5\text{ V}$	
Output leakage current	I_{LO}	-10	10	-10	10	-10	10	μA	$0\text{ V} \leq V_{out} \leq 5.5\text{ V}$ Dout = disable	
Output high voltage	V_{OH}	2.4	V_{CC}	2.4	V_{CC}	2.4	V_{CC}	V	High Iout = -2 mA	
Output low voltage	V_{OL}	0	0.4	0	0.4	0	0.4	V	Low Iout = 2 mA	

Notes: 1. I_{CC} depends on output load condition when the device is selected, I_{CC} max is specified at the output open condition.

2. Address can be changed once or less while $\overline{RAS} = V_{IL}$.

3. Address can be changed once or less while $\overline{CAS} = V_{IH}$.

Capacitance ($T_a = 25^\circ\text{C}$, $V_{CC} = 5\text{ V} \pm 5\%$)

Parameter	Symbol	Typ	Max	Unit	Notes
Input capacitance (Address)	C_{I1}	—	200	pF	1
Input capacitance ($\overline{CAS}$)	C_{I2}	—	62	pF	1
Input capacitance ($\overline{RAS}$)	C_{I3}	—	83	pF	1
Input capacitance ($\overline{WE}, \overline{OE}$)	C_{I4}	—	146	pF	1
Output capacitance (DQ)	C_{IO}	—	27	pF	1, 2

Notes: 1. Capacitance measured with Boonton Meter or effective capacitance measuring method.

2. $\overline{CAS} = V_{IH}$ to disable Dout.

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AC Characteristics ($T_a = 0$ to 70°C , $V_{CC} = 5\text{ V} \pm 5\%$, $V_{SS} = 0\text{ V}$)^{*1, *2, *18, *19}

- Input rise and fall times: 2 ns
- Input levels: 0 V, 3.0 V
- Input timing reference levels: 0.8 V, 2.4 V
- Output timing reference levels: 0.8 V, 2.0 V
- Output load: 1 TTL gate + C_L (100 pF) (Including scope and jig)

Read, Write, Read-Modify-Write and Refresh Cycles (Common parameters)

		HB56S872ESN							
		-6B		-7B		-8B			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Random read or write cycle time	t_{RC}	104	—	124	—	144	—	ns	
$\overline{\text{RAS}}$ precharge time	t_{RP}	40	—	50	—	60	—	ns	
$\overline{\text{CAS}}$ precharge time	t_{CP}	10	—	13	—	15	—	ns	
$\overline{\text{RAS}}$ pulse width	t_{RAS}	60	10000	70	10000	80	10000	ns	
$\overline{\text{CAS}}$ pulse width	t_{CAS}	10	10000	13	10000	15	10000	ns	
Row address setup time	t_{ASR}	0	—	0	—	0	—	ns	
Row address hold time	t_{RAH}	10	—	10	—	10	—	ns	
Column address setup time	t_{ASC}	0	—	0	—	0	—	ns	
Column address hold time	t_{CAH}	10	—	13	—	15	—	ns	
$\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ delay time	t_{RCD}	20	45	20	52	20	60	ns	3
$\overline{\text{RAS}}$ to column address delay time	t_{RAD}	15	30	15	35	15	40	ns	4
$\overline{\text{RAS}}$ hold time	t_{RSH}	15	—	18	—	20	—	ns	
$\overline{\text{CAS}}$ hold time	t_{CSH}	48	—	58	—	68	—	ns	
$\overline{\text{CAS}}$ to $\overline{\text{RAS}}$ precharge time	t_{CRP}	5	—	5	—	5	—	ns	
$\overline{\text{OE}}$ to Din delay time	t_{OED}	15	—	18	—	20	—	ns	5
$\overline{\text{OE}}$ delay time from Din	t_{DZO}	0	—	0	—	0	—	ns	6
$\overline{\text{CAS}}$ delay time from Din	t_{DZC}	0	—	0	—	0	—	ns	6
Transition time (rise and fall)	t_T	2	50	2	50	2	50	ns	7
Refresh period	t_{REF}	—	64	—	64	—	64	ms	

Read Cycle

		HB56S872ESN							
		-6B		-7B		-8B			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Access time from $\overline{\text{RAS}}$	t_{RAC}	—	60	—	70	—	80	ns	8, 9
Access time from $\overline{\text{CAS}}$	t_{CAC}	—	15	—	18	—	20	ns	9, 10, 17
Access time from address	t_{AA}	—	30	—	35	—	40	ns	9, 11, 17
Access time from $\overline{\text{OE}}$	t_{OEA}	—	15	—	18	—	20	ns	9, 21
Read command setup time	t_{RCS}	0	—	0	—	0	—	ns	
Read command hold time to $\overline{\text{CAS}}$	t_{RCH}	0	—	0	—	0	—	ns	12
Read command hold time from $\overline{\text{RAS}}$	t_{RCHR}	60	—	70	—	80	—	ns	
Read command hold time to $\overline{\text{RAS}}$	t_{RRH}	0	—	0	—	0	—	ns	12
Column address to $\overline{\text{RAS}}$ lead time	t_{RAL}	30	—	35	—	40	—	ns	
Column address to $\overline{\text{CAS}}$ lead time	t_{CAL}	18	—	23	—	28	—	ns	
$\overline{\text{CAS}}$ to output in low-Z	t_{CLZ}	0	—	0	—	0	—	ns	
Output data hold time	t_{OH}	3	—	3	—	3	—	ns	
Output data hold time from $\overline{\text{OE}}$	t_{OHO}	3	—	3	—	3	—	ns	
Output buffer turn-off time	t_{OFF}	—	15	—	15	—	15	ns	13
Output buffer turn-off to $\overline{\text{OE}}$	t_{OEZ}	—	15	—	15	—	15	ns	13
$\overline{\text{CAS}}$ to Din delay time	t_{CDD}	15	—	18	—	20	—	ns	5
Output data hold time from $\overline{\text{RAS}}$	t_{OHR}	3	—	3	—	3	—	ns	
Output buffer turn-off time to $\overline{\text{RAS}}$	t_{OFR}	—	15	—	15	—	15	ns	
Output buffer turn-off to $\overline{\text{WE}}$	t_{WEZ}	—	15	—	15	—	15	ns	
$\overline{\text{WE}}$ to Din delay time	t_{WED}	15	—	18	—	20	—	ns	
$\overline{\text{RAS}}$ to Din delay time	t_{RDD}	15	—	18	—	20	—	ns	

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Write Cycle

		HB56S872ESN							
		-6B		-7B		-8B			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Write command setup time	t_{WCS}	0	—	0	—	0	—	ns	14
Write command hold time	t_{WCH}	10	—	13	—	15	—	ns	
Write command pulse width	t_{WP}	10	—	10	—	10	—	ns	
Write command to $\overline{RAS}$ lead time	t_{RWL}	10	—	13	—	15	—	ns	
Write command to $\overline{CAS}$ lead time	t_{CWL}	10	—	13	—	15	—	ns	
Data-in setup time	t_{DS}	0	—	0	—	0	—	ns	15
Data-in hold time	t_{DH}	10	—	13	—	15	—	ns	15

Read-Modify-Write Cycle

		HB56S872ESN							
		-6B		-7B		-8B			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Read-modify-write cycle time	t_{RWC}	149	—	175	—	199	—	ns	
$\overline{RAS}$ to $\overline{WE}$ delay time	t_{RWD}	82	—	95	—	107	—	ns	14
$\overline{CAS}$ to $\overline{WE}$ delay time	t_{CWD}	37	—	43	—	47	—	ns	14
Column address to $\overline{WE}$ delay time	t_{AWD}	52	—	60	—	67	—	ns	14
$\overline{OE}$ hold time from $\overline{WE}$	t_{OEH}	15	—	18	—	20	—	ns	

Refresh Cycle

		HB56S872ESN							
		-6B		-7B		-8B			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
$\overline{CAS}$ setup time (CBR refresh cycle)	t_{CSR}	5	—	5	—	5	—	ns	
$\overline{CAS}$ hold time (CBR refresh cycle)	t_{CHR}	10	—	10	—	10	—	ns	
$\overline{WE}$ setup time (CBR refresh cycle)	t_{WRP}	0	—	0	—	0	—	ns	
$\overline{WE}$ hold time (CBR refresh cycle)	t_{WRH}	10	—	10	—	10	—	ns	
$\overline{RAS}$ precharge to $\overline{CAS}$ hold time	t_{RPC}	0	—	0	—	0	—	ns	

EDO Page Mode Cycle

		HB56S872ESN							
		-6B		-7B		-8B			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
EDO page mode cycle time	t_{HPC}	25	—	30	—	35	—	ns	20
EDO page mode $\overline{RAS}$ pulse width	t_{RASP}	—	100000	—	100000	—	100000	ns	16
Access time from $\overline{CAS}$ precharge	t_{CPA}	—	35	—	40	—	45	ns	9, 17
$\overline{RAS}$ hold time from $\overline{CAS}$ precharge	t_{CPRH}	35	—	40	—	45	—	ns	
Output data hold time from $\overline{CAS}$ low	t_{DOH}	3	—	3	—	3	—	ns	9, 17
$\overline{CAS}$ hold time referred $\overline{OE}$	t_{COL}	10	—	13	—	15	—	ns	
$\overline{CAS}$ to $\overline{OE}$ setup time	t_{COP}	5	—	5	—	5	—	ns	
Read command hold time from $\overline{CAS}$ precharge	t_{RCHC}	35	—	40	—	45	—	ns	

EDO Page Mode Read-Modify-Write Cycle

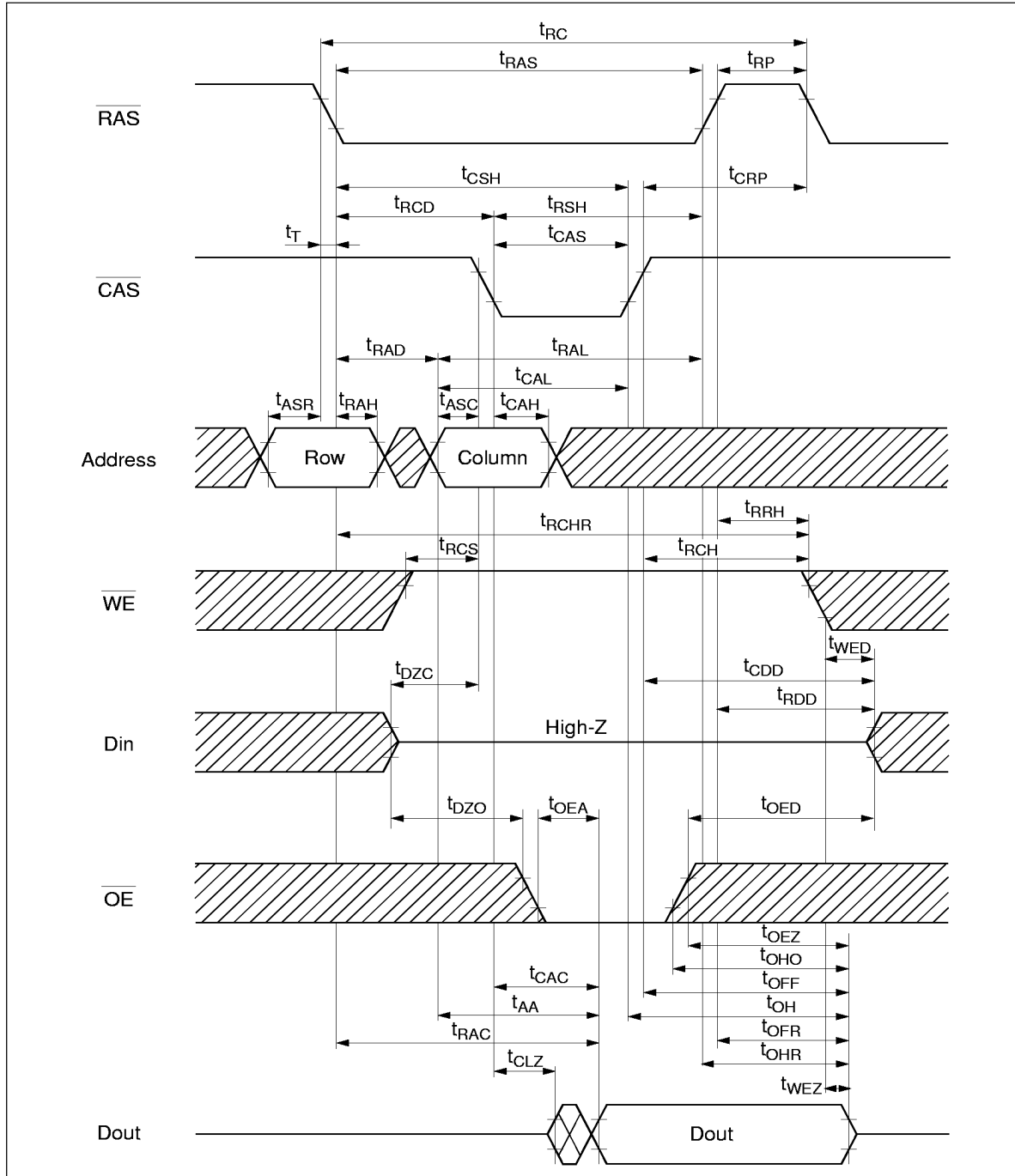
		HB56S872ESN							
		-6B		-7B		-8B			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
EDO page mode read-modify-write cycle time	t_{HPRWC}	79	—	90	—	99	—	ns	
$\overline{WE}$ delay time from $\overline{CAS}$ precharge	t_{CPW}	54	—	62	—	69	—	ns	14

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- Notes:
1. AC measurements assume $t_T = 2 \text{ ns}$.
 2. An initial pause of $200 \mu\text{s}$ is required after power up followed by a minimum of eight initialization cycles (any combination of cycles containing $\overline{\text{RAS}}$ -only refresh cycle or $\overline{\text{CAS}}$ -before-RAS refresh).
 3. Operation with the t_{RCD} (max) limit insures that t_{RAC} (max) can be met, t_{RCD} (max) is specified as a reference point only; if $t_{\text{RCD}} \geq t_{\text{RCD}} (\text{max}) + t_{\text{AA}} (\text{max}) - t_{\text{CAC}} (\text{max})$, then access time is controlled exclusively by t_{CAC} .
 4. Operation with the t_{RAD} (max) limit insures that t_{RAC} (max) can be met, t_{RAD} (max) is specified as a reference point only; if t_{RAD} is greater than the specified t_{RAD} (max) limit, then access time is controlled exclusively by t_{AA} .
 5. Either t_{OED} or t_{CDD} must be satisfied.
 6. Either t_{DZO} or t_{DZC} must be satisfied.
 7. V_{IH} (min) and V_{IL} (max) are reference levels for measuring timing of input signals. Also, transition times are measured between V_{IH} (min) and V_{IL} (max).
 8. Assumes that $t_{\text{RCD}} \leq t_{\text{RCD}} (\text{max})$ and $t_{\text{RAD}} \leq t_{\text{RAD}} (\text{max})$. If t_{RCD} or t_{RAD} is greater than the maximum recommended value shown in this table, t_{RAC} exceeds the value shown.
 9. Measured with a load circuit equivalent to 1TTL loads and 100 pF.
 10. Assumes that $t_{\text{RCD}} \geq t_{\text{RCD}} (\text{max})$ and $t_{\text{RCD}} + t_{\text{CAC}} (\text{max}) \geq t_{\text{RAD}} + t_{\text{AA}} (\text{max})$.
 11. Assumes that $t_{\text{RAD}} \geq t_{\text{RAD}} (\text{max})$ and $t_{\text{RCD}} + t_{\text{CAC}} (\text{max}) \leq t_{\text{RAD}} + t_{\text{AA}} (\text{max})$.
 12. Either t_{RCH} or t_{RRH} must be satisfied for a read cycles.
 13. $t_{\text{OFF}} (\text{max})$ and $t_{\text{OEZ}} (\text{max})$ define the time at which the outputs achieve the open circuit condition and are not referred to output voltage levels.
 14. t_{WCS} , t_{RWD} , t_{CWD} , t_{AWD} and t_{CPW} are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only; if $t_{\text{WCS}} \geq t_{\text{WCS}} (\text{min})$, the cycle is an early write cycle and the data out pin will remain open circuit (high impedance) throughout the entire cycle; if $t_{\text{RWD}} \geq t_{\text{RWD}} (\text{min})$, $t_{\text{CWD}} \geq t_{\text{CWD}} (\text{min})$, and $t_{\text{AWD}} \geq t_{\text{AWD}} (\text{min})$ or $t_{\text{CWD}} \geq t_{\text{CWD}} (\text{min})$, $t_{\text{AWD}} \geq t_{\text{AWD}} (\text{min})$ and $t_{\text{CPW}} \geq t_{\text{CPW}} (\text{min})$, the cycle is a read-modify-write and the data output will contain data read from the selected cell; if neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminate.
 15. These parameters are referred to $\overline{\text{CAS}}$ leading edge in early write cycles and to $\overline{\text{WE}}$ leading edge in delayed write or read-modify-write cycles.
 16. t_{RASp} defines $\overline{\text{RAS}}$ pulse width in EDO page mode cycles.
 17. Access time is determined by the longest among t_{AA} , t_{CAC} and t_{CPA} .
 18. In delayed write or read-modify-write cycles, $\overline{\text{OE}}$ must disable output buffer prior to applying data to the device. After $\overline{\text{RAS}}$ is reset, if $t_{\text{OEH}} \geq t_{\text{CWL}}$, the DQ pin will remain open circuit (high impedance); if $t_{\text{OEH}} < t_{\text{CWL}}$, invalid data will be out at each DQ.
 19. All the V_{CC} and V_{SS} pins shall be supplied with the same voltages.
 20. $t_{\text{HPC}} (\text{min})$ can be achieved during a series of EDO page mode write cycles or EDO page mode read cycles. If both write and read operation are mixed in a EDO page mode $\overline{\text{RAS}}$ cycle (EDO page mode mix cycle (1), (2)), minimum value of $\overline{\text{CAS}}$ cycle ($t_{\text{CAS}} + t_{\text{CP}} + 2t_T$) becomes greater than the specified $t_{\text{HPC}} (\text{min})$ value. The value of $\overline{\text{CAS}}$ cycle time of mixed EDO page mode is shown in EDO page mode mix cycle (1) and (2).
 21. When output buffers are enabled once, sustain the low impedance state until valid data is obtained. When output buffer is turned on and off within a very short time, generally it causes large $V_{\text{CC}} / V_{\text{SS}}$ line noise, which causes to degrade $V_{\text{IH}} \text{ min} / V_{\text{IL}} \text{ max}$ level.

Timing Waveforms

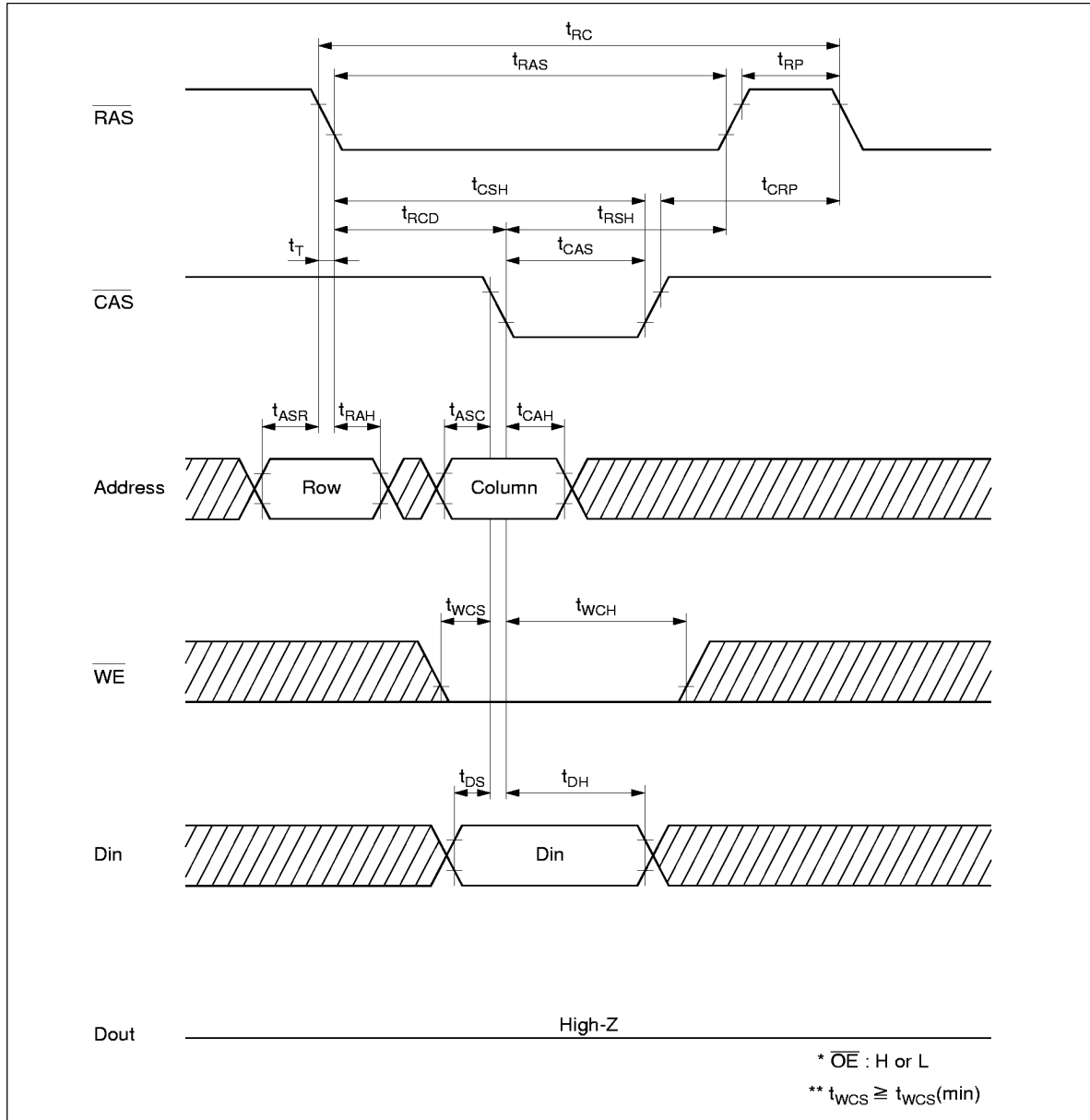
Read Cycle



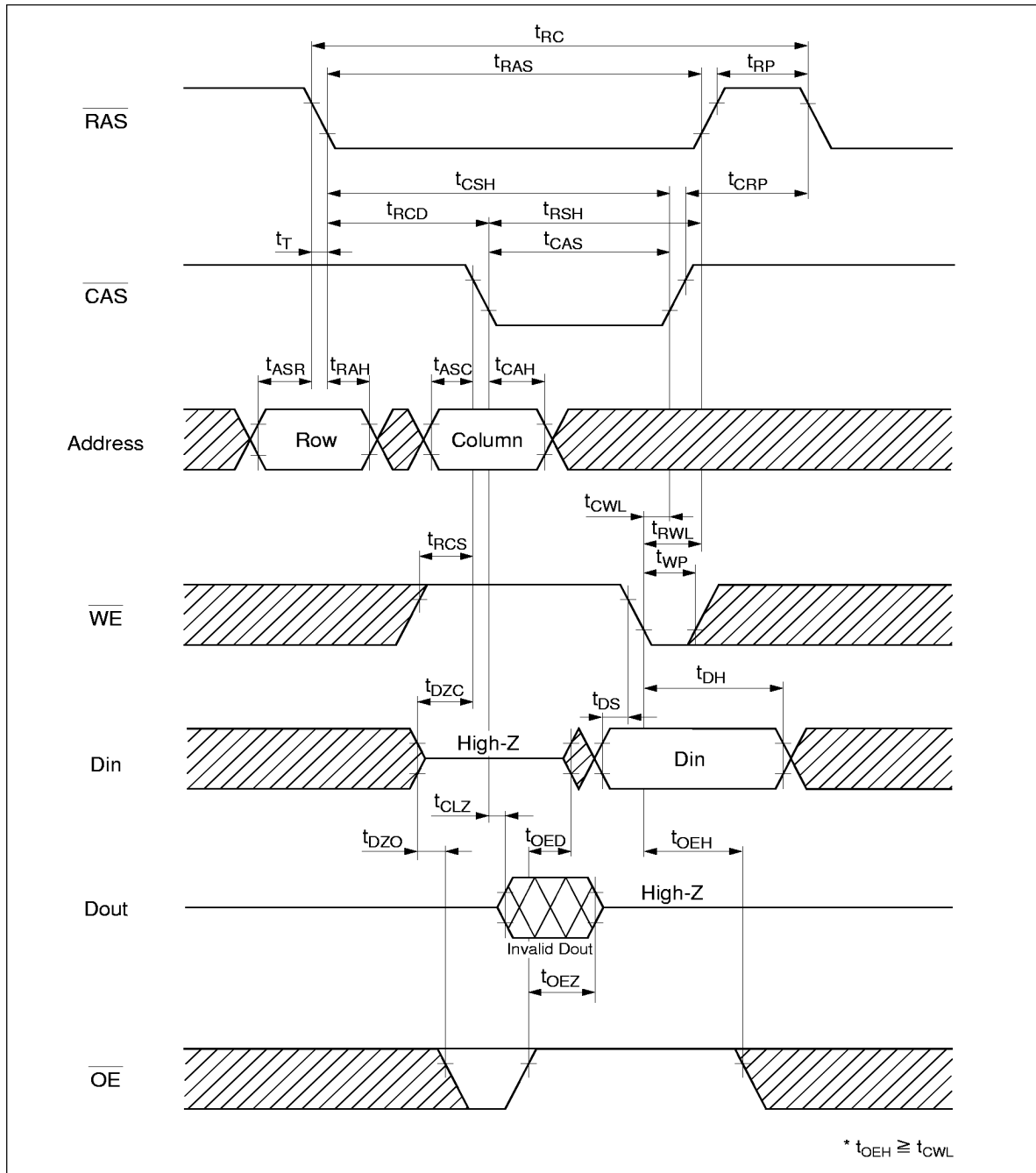
HB56S872ESN-6B/7B/8B

Note : ///
H or L (H: $V_{IH}(\min) \leq V_{IN} \leq V_{IH}(\max)$, L: $V_{IL}(\min) \leq V_{IN} \leq V_{IL}(\max)$)
XXX: Invalid Dout

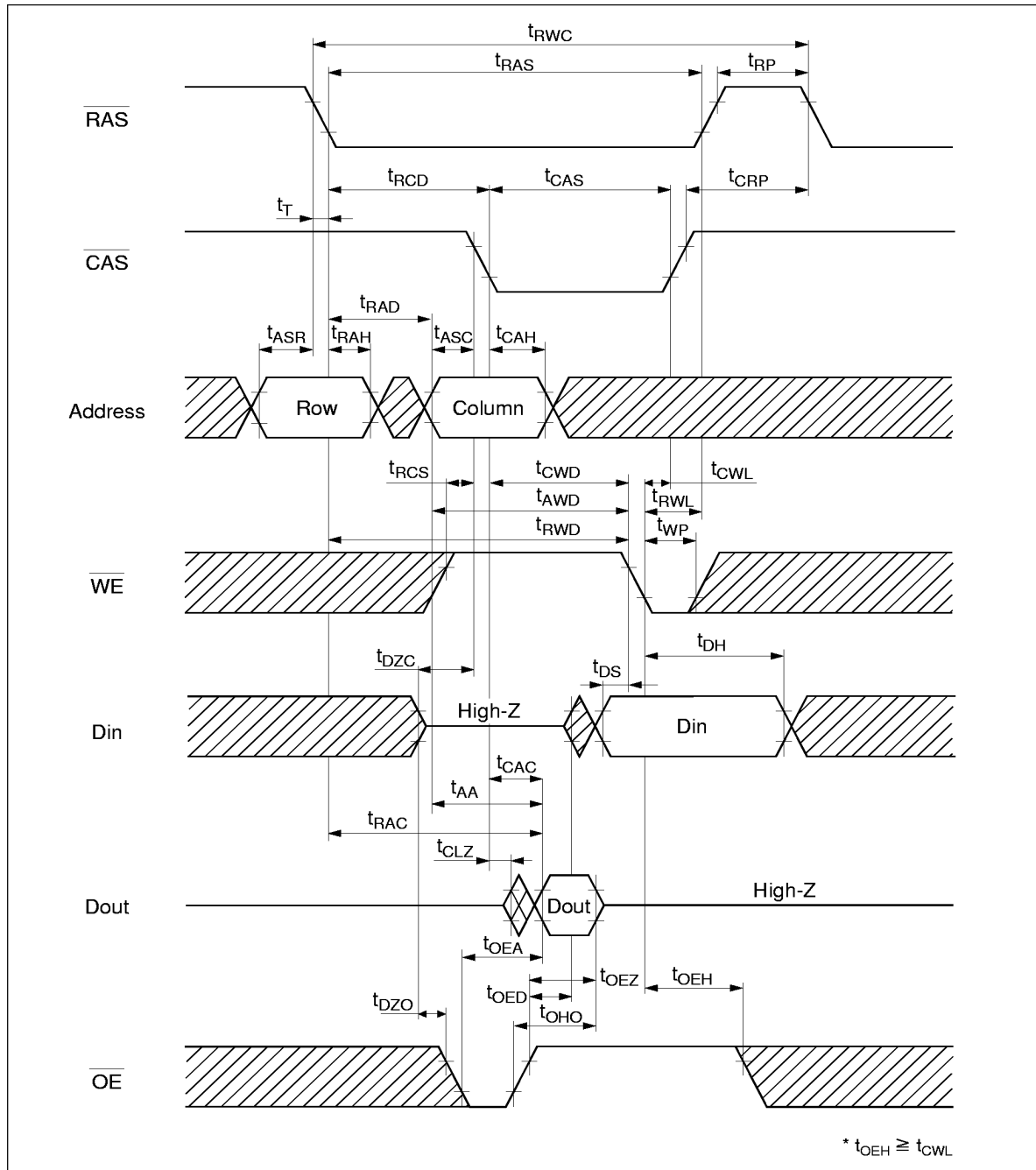
Early Write Cycle



Delayed Write Cycle

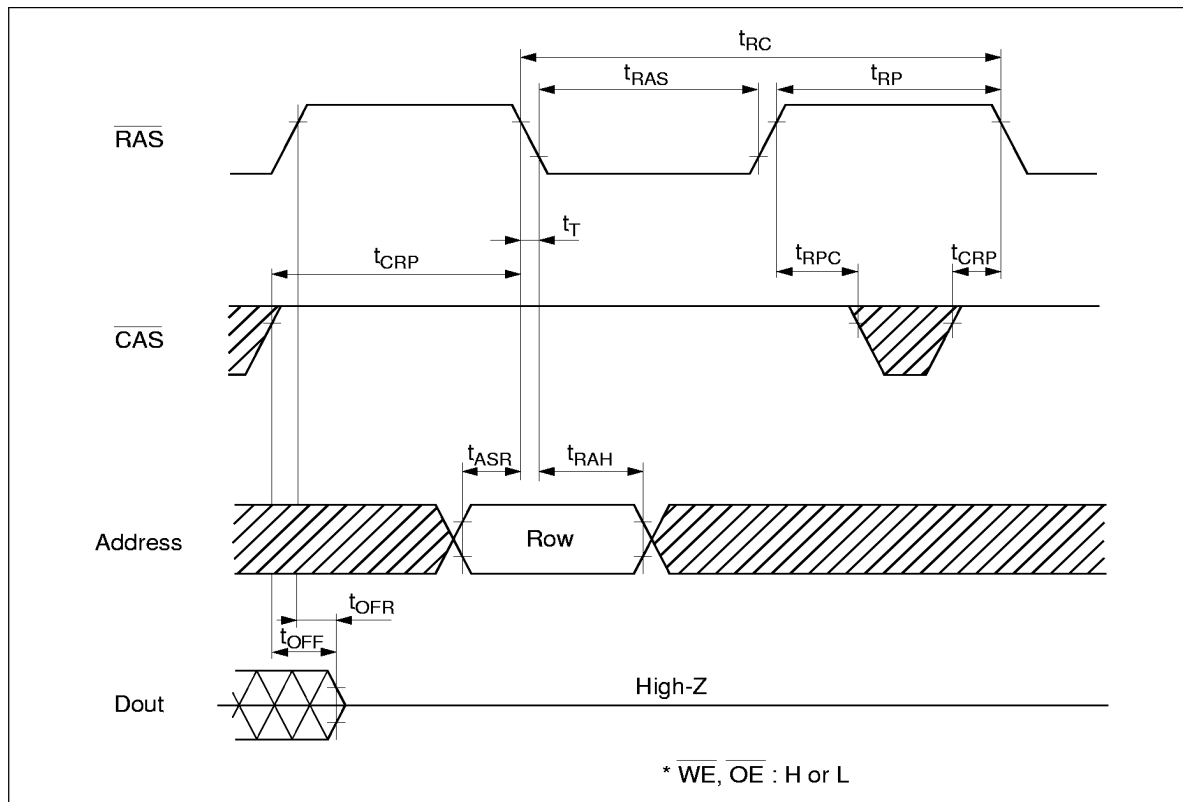


Read-Modify-Write Cycle

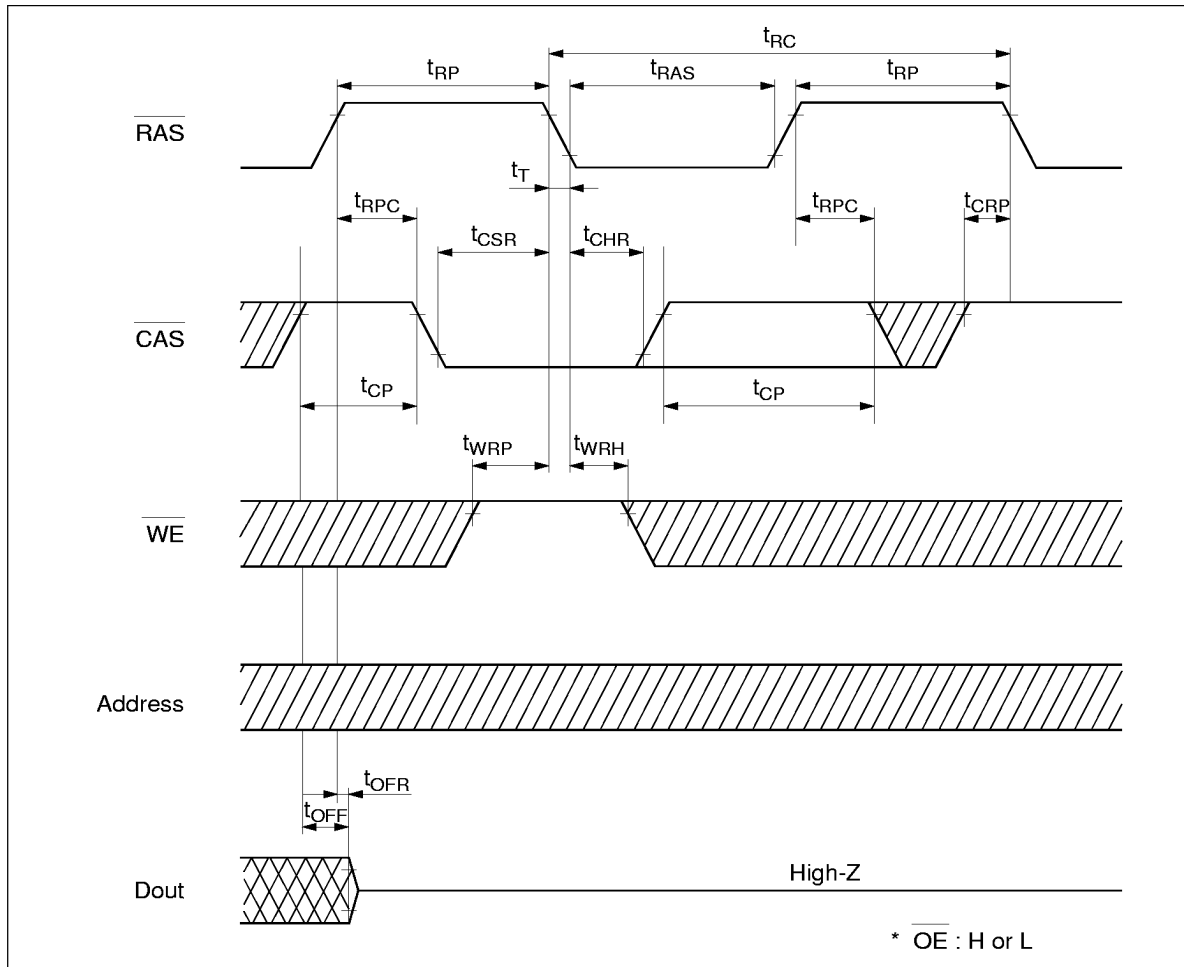


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$\overline{\text{RAS}}$ -Only Refresh Cycle

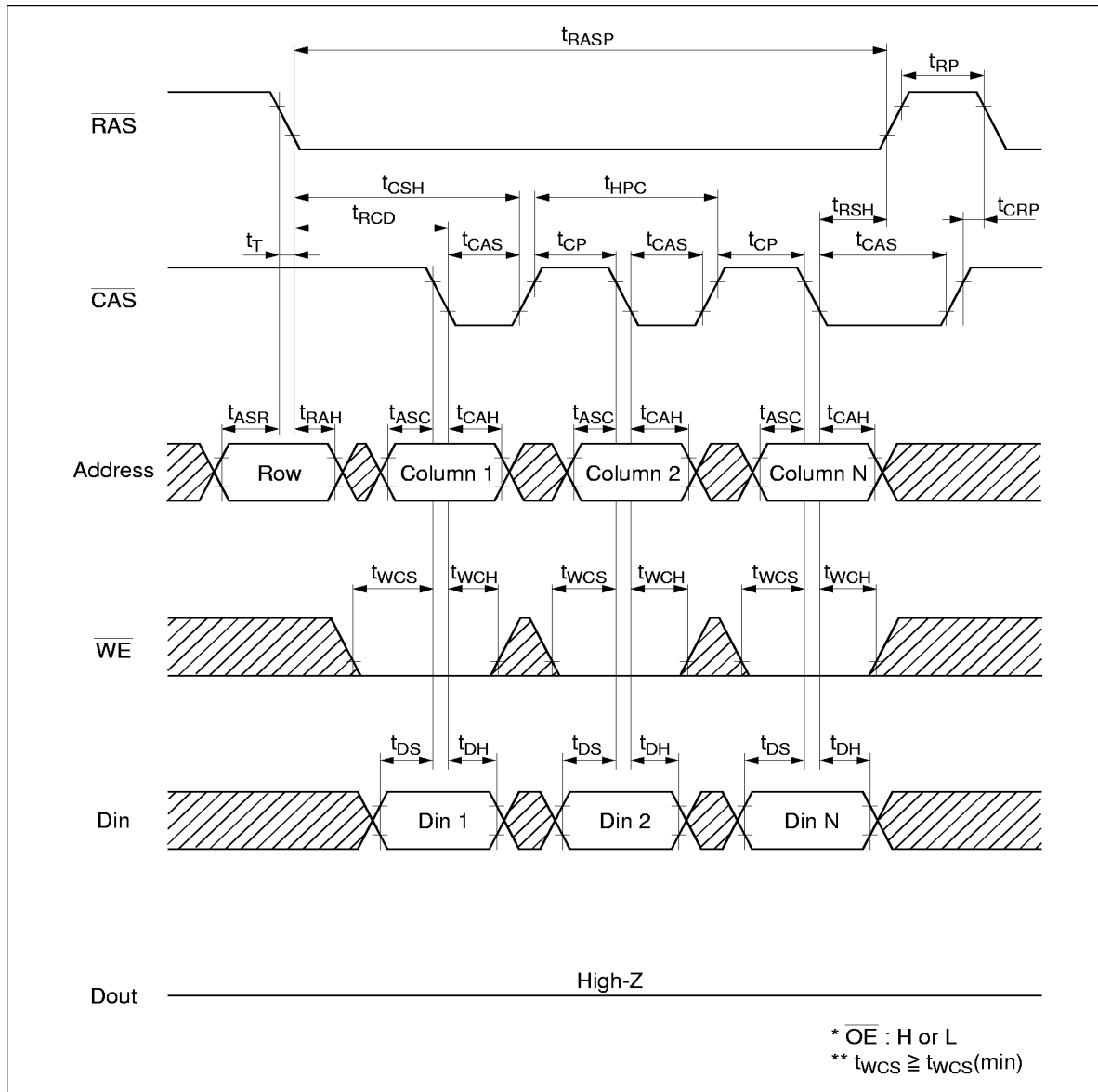


CAS-Before-RAS Refresh Cycle



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EDO Page Mode Early Write Cycle



Physical Outline

Unit: mm/inch

